SDAS214C - DECEMBER 1982 - REVISED AUGUST 1995

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

These octal buffers/drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. When these devices are used with the 'ALS241, 'AS241A, 'ALS244, and 'AS244A, the circuit designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable (\overline{OE}) inputs, and complementary OE and \overline{OE} inputs. These devices feature high fan-out and improved fan-in.

The -1 version of SN74ALS240A is identical to the standard version, except that the recommended maximum I_{OL} for the -1 version is 48 mA. There is no -1 version of the SN54ALS240A.

The SN54ALS240A and SN54AS240A are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS240A and SN74AS240A are characterized for operation from 0°C to 70°C.

SN54ALS240A, SN54AS240A J PACKAGE
SN74ALS240A, SN74AS240A DW OR N PACKAGE
(TOP VIEW)

(,	
[2 [3	20 19 18	V <u>CC</u> 20E 1Y1
	17	2A4
	16] 1Y2
6	15	2A3
[7]	14] 1Y3
8]]	13	2A2
9	12] 1Y4
10) 11	2A1
		$\begin{bmatrix} 2 & 19 \\ 3 & 18 \\ 4 & 17 \\ 5 & 16 \\ 6 & 15 \\ 7 & 14 \\ 8 & 13 \end{bmatrix}$

SN54ALS240A, SN54AS240A . . . FK PACKAGE

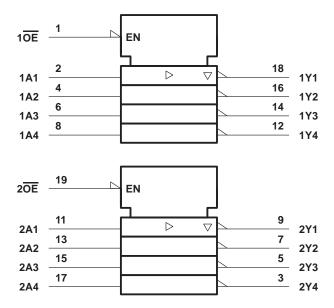
FUNCTION TABLE	
(each buffer)	

(1.1.1.1.1.)							
INP	JTS	OUTPUT					
OE	Α	Y					
L	Н	L					
L	L	н					
н	Х	Z					

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

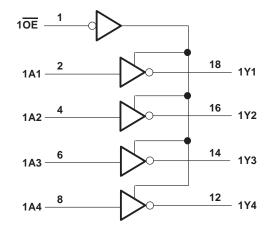
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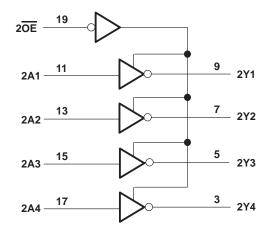
logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Input voltage, V ₁	
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T _A : SN54ALS240A	-55°C to 125°C
SN74ALS240A	0°C to 70°C
Storage temperature range	–65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



SDAS214C - DECEMBER 1982 - REVISED AUGUST 1995

recommended operating conditions

		SN54ALS240A			SN7	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ЮН	High-level output current			-12			-15	mA
	Low-level output current			12			24	mA
OL							48†	ША
TA	Operating free-air temperature	-55		125	0		70	°C

[†] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS		SN	54ALS24	0A	SN7	74ALS24	0A	
PARAMETER			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lı = -18 mA			-1.2			-1.2	V
	$V_{CC} = 4.5 V \text{ to } 5.5 V,$	I _{OH} = -0.4 mA	V _{CC} -2	2		V _{CC} -2	2		
Veri		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH	$V_{CC} = 4.5 V$	I _{OH} = -12 mA	2						v
		I _{OH} = -15 mA				2			
		I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
VOL	$V_{CC} = 4.5 V$	I _{OL} = 24 mA					0.35	0.5	V
		$I_{OL} = 48 \text{ mA}^{\dagger}$					0.35	0.5	
IOZH	$V_{CC} = 5.5 V,$	V _O = 2.7 V			20			20	μA
I _{OZL}	$V_{CC} = 5.5 V,$	V _O = 0.4 V			-20			-20	μΑ
lj	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
Iн	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
۱ _{IL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA
١ _O §	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
		Outputs high		4	11		4	11	
ICC	V _{CC} = 5.5 V	Outputs low		13	23		13	23	mA
		Outputs disabled		14	25		14	25	

 † Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. § The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .



SDAS214C - DECEMBER 1982 - REVISED AUGUST 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL R1 R2	= 50 pF = 500 9 2 = 500 9	2,	3	UNIT	
				SN54ALS240A		SN74ALS240A		
			MIN	MAX	MIN	MAX		
^t PLH	А	v	2	22	2	9	ns	
^t PHL	A	Y	2	11	2	9	115	
^t PZH	OE	Y	4	34	5	13	ns	
tPZL	ÛE	Ϋ́	5	26	5	18	115	
^t PHZ	OE	V	1	15	2	10	ns	
^t PLZ	UE		3	24	3	12	115	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Input voltage, V ₁	
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T _A : SN54AS240A	-55°C to 125°C
SN74AS240A	0°C to 70°C
Storage temperature range	-65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	54AS24	DA	SN	74AS24	DA	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
IOH	High-level output current			-12			-15	mA
IOL	Low-level output current			48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C



SDAS214C - DECEMBER 1982 - REVISED AUGUST 1995

DADAMETED	TERTO	TEST CONDITIONS SN54AS240A			SN54AS240A		SN74AS240A		
PARAMETER	IESIC	ONDITIONS	MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lj = -18 mA			-1.2			-1.2	V
		$I_{OH} = -2 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2		
Varia	V_{CC} = 4.5 V to 5.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.4		2.4	3.4		V
VOH		I _{OH} = -12 mA	2.4						v
	$V_{CC} = 4.5 V$	I _{OH} = -15 mA				2.4			
Mai		I _{OL} = 48 mA		0.27	0.55				
VOL	$V_{CC} = 4.5 V$	I _{OL} = 64 mA					0.31	0.55 V	
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V			50			50	μΑ
IOZL	V _{CC} = 5.5 V,	$V_{O} = 0.4 V$			-50			-50	μΑ
l	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
Ін	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
A inputs					-1			-1	mA
	$V_{CC} = 5.5 V,$	$V_{I} = 0.4 V$			-0.5			-0.5	mA
IO [‡]	V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-150	-50		-150	mA
		Outputs high		11	17		11	17	
ICC	V _{CC} = 5.5 V	Outputs low		51	75		51	75	mA
		Outputs disabled		24	38		24	38	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

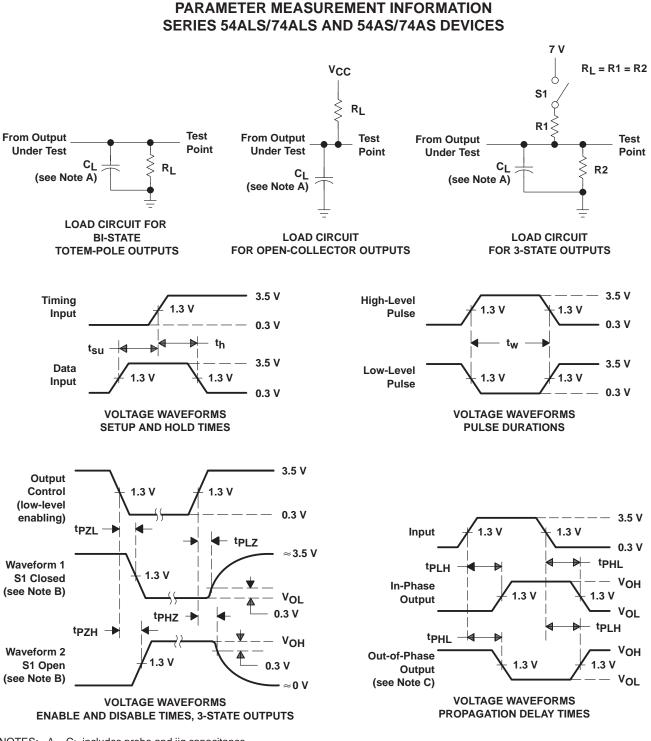
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T _A = MIN to MAX§				UNIT
			SN54AS240A		SN74AS240A		
			MIN	MAX	MIN	MAX	
^t PLH	A	Y	1	7	1	6.5	ns
^t PHL			1.2	6.5	1.2	6.5	
^t PZH	OE	Y	1	7	1	6.4	ns
t _{PZL}			1.1	9.5	1.1	9	
^t PHZ	OE	Y	1.2	5.5	1.2	5	ns
t _{PLZ}			1.5	12.5	1.5	9.5	

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SDAS214C - DECEMBER 1982 - REVISED AUGUST 1995



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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